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# **2SK2684(L), 2SK2684(S)**

**Silicon N Channel DV-L MOS FET**  
**High Speed Power Switching**

**HITACHI**

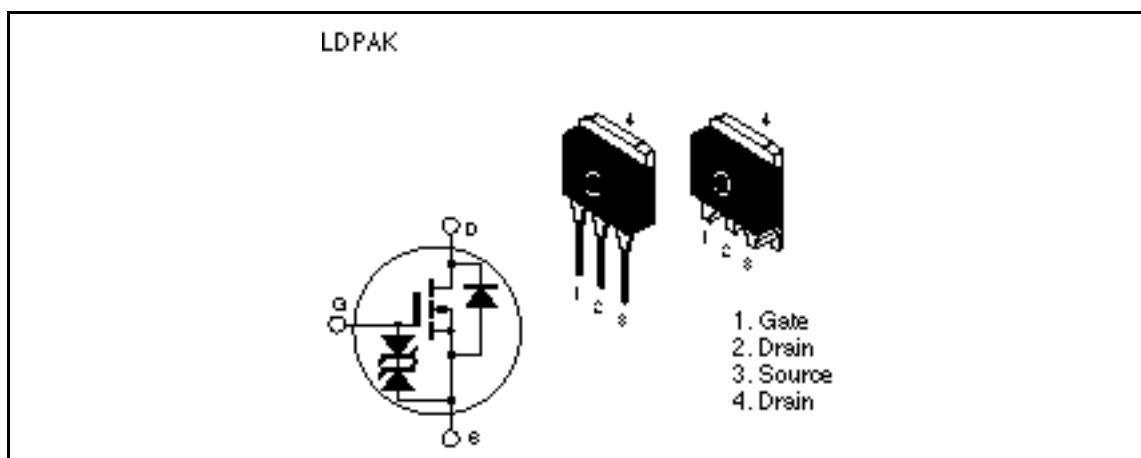
ADE-208-542  
1st. Edition

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## **Features**

- Low on-resistance  
 $R_{DS(on)} = 20 \text{ m\Omega}$  typ. ( $V_{GS} = 10V$ ,  $I_D = 15 \text{ A}$ )
- 4V gate drive devices.
- High speed switching

## **Outline**



## **2SK2684(L), 2SK2684(S)**

### **Absolute Maximum Ratings (Ta = 25°C)**

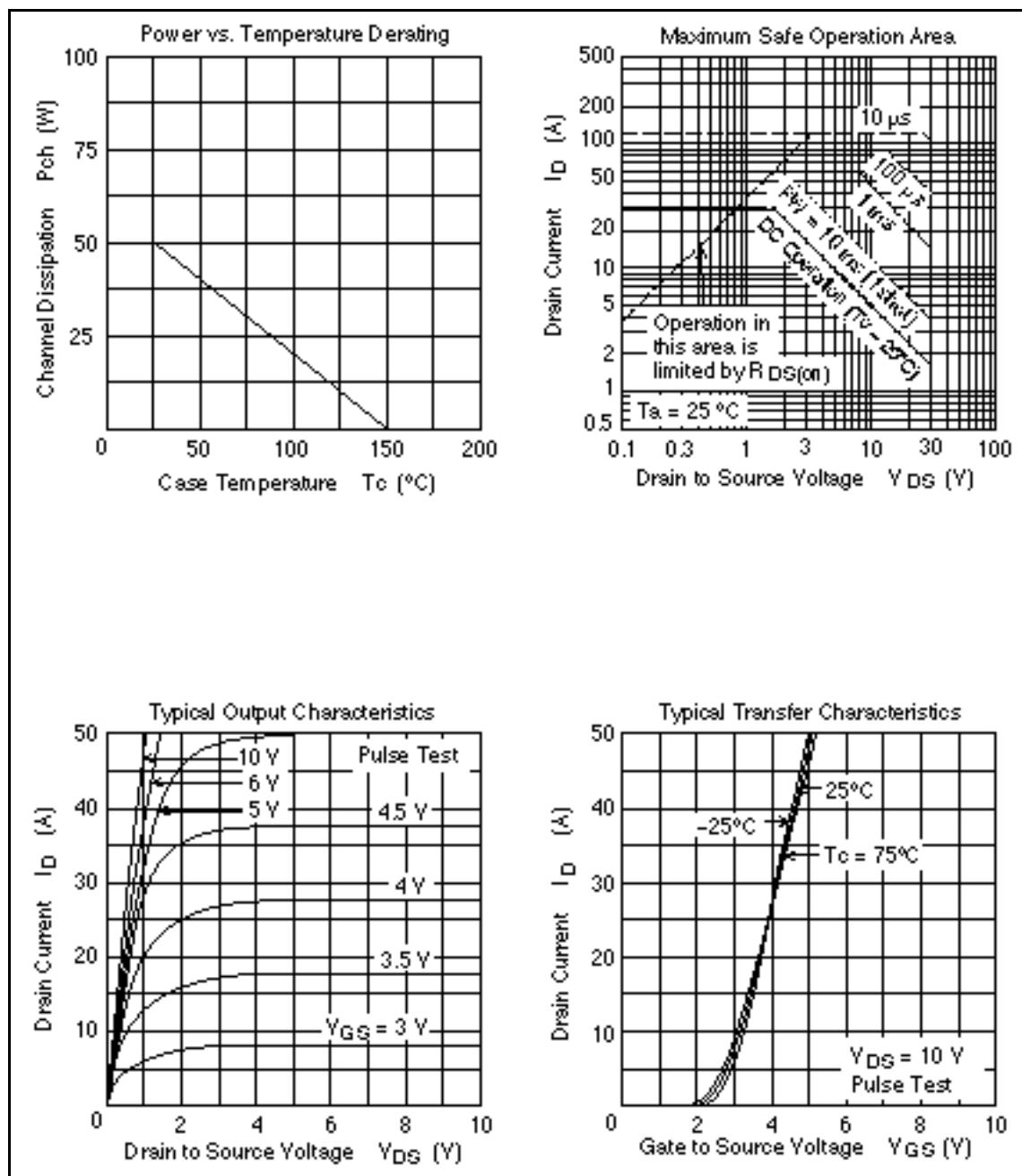
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	30	A
Drain peak current	I <sub>D(pulse)</sub> <sup>*1</sup>	120	A
Body to drain diode reverse drain current	I <sub>DR</sub>	30	A
Channel dissipation	Pch <sup>*2</sup>	50	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Notes: 1. PW 10μs, duty cycle 1 %  
       2. Value at T<sub>c</sub> = 25°C

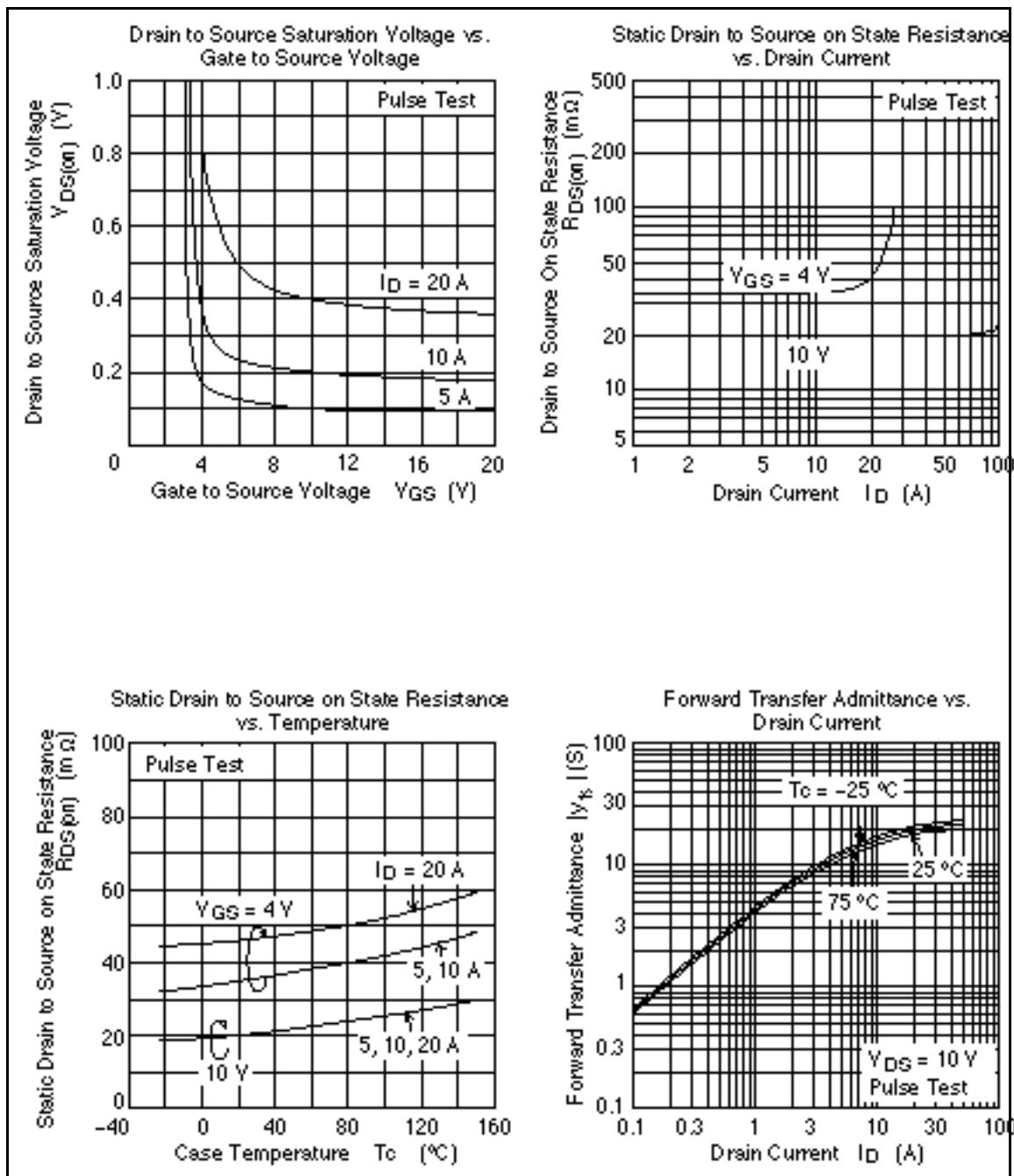
### **Electrical Characteristics (Ta = 25°C)**

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	—	—	V	I <sub>D</sub> = 10mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	I <sub>G</sub> = ±100μA, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	10	μA	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±16V, V <sub>DS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.0	—	2.0	V	I <sub>D</sub> = 1mA, V <sub>DS</sub> = 10V
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	20	28	m	I <sub>D</sub> = 15A, V <sub>GS</sub> = 10V <sup>*1</sup>
Forward transfer admittance	y <sub>fs</sub>	12	18	—	S	I <sub>D</sub> = 15A, V <sub>DS</sub> = 10V <sup>*1</sup>
Input capacitance	C <sub>iss</sub>	—	750	—	pF	V <sub>DS</sub> = 10V
Output capacitance	C <sub>oss</sub>	—	520	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	210	—	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	—	16	—	ns	V <sub>GS</sub> = 10V, I <sub>D</sub> = 15A
Rise time	t <sub>r</sub>	—	260	—	ns	R <sub>L</sub> = 0.67
Turn-off delay time	t <sub>d(off)</sub>	—	85	—	ns	
Fall time	t <sub>f</sub>	—	90	—	ns	
Body to drain diode forward voltage	V <sub>DF</sub>	—	1.0	—	V	I <sub>F</sub> = 30A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	45	—	ns	I <sub>F</sub> = 30A, V <sub>GS</sub> = 0 dI <sub>F</sub> /dt = 50A/μs

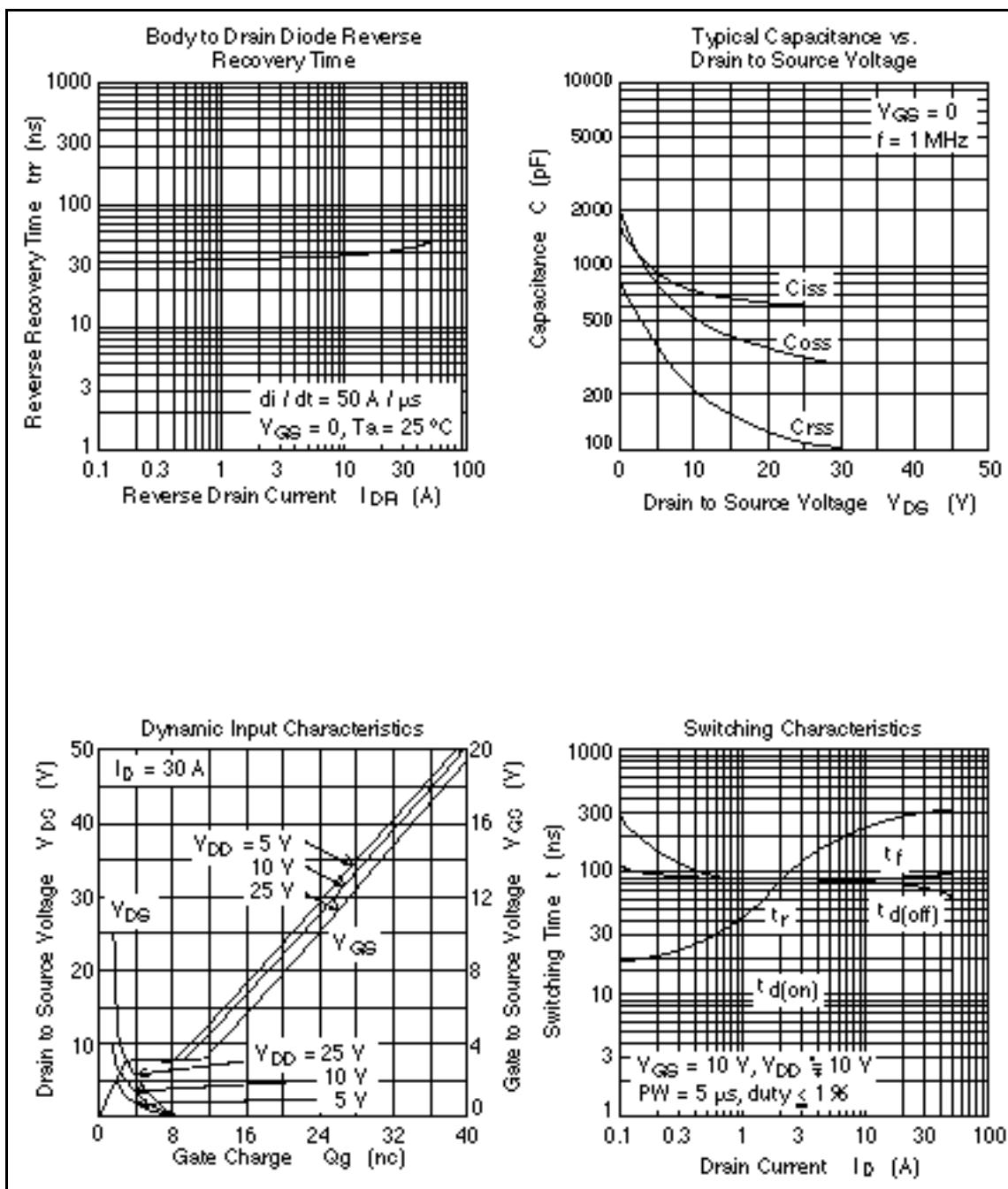
Note: 1. Pulse test

**Main Characteristics**

## **2SK2684(L), 2SK2684(S)**



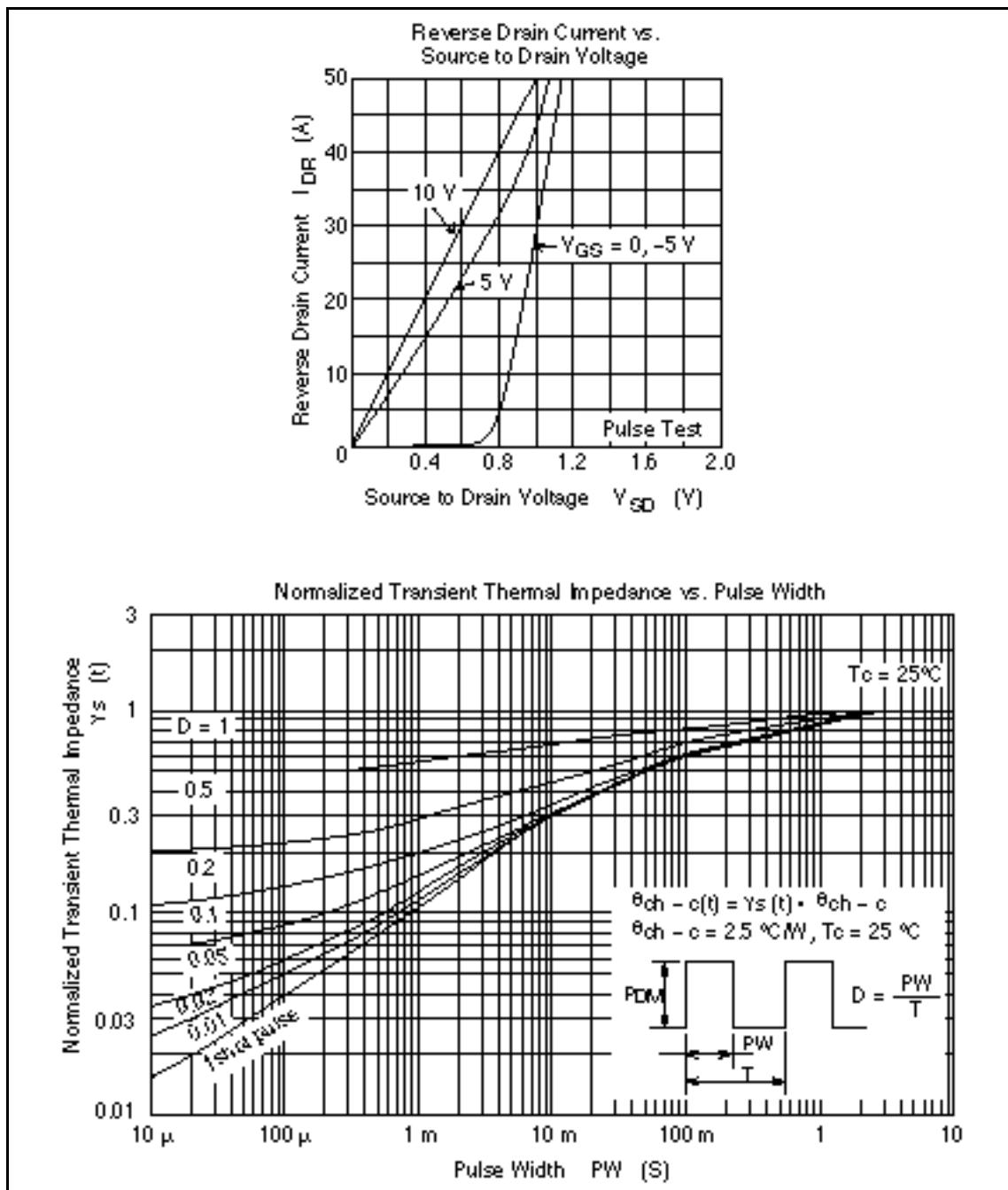
## 2SK2684(L), 2SK2684(S)



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## **2SK2684(L), 2SK2684(S)**

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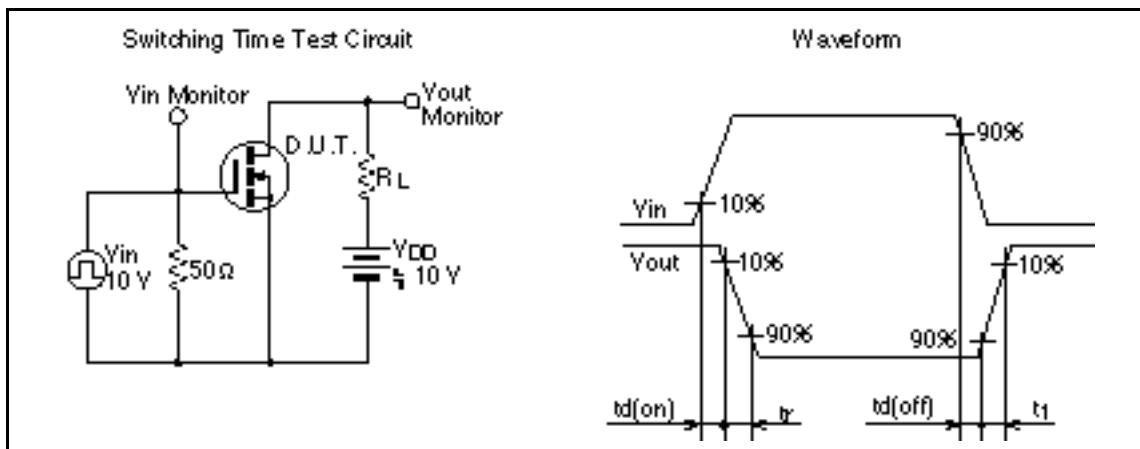


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## **2SK2684(L), 2SK2684(S)**

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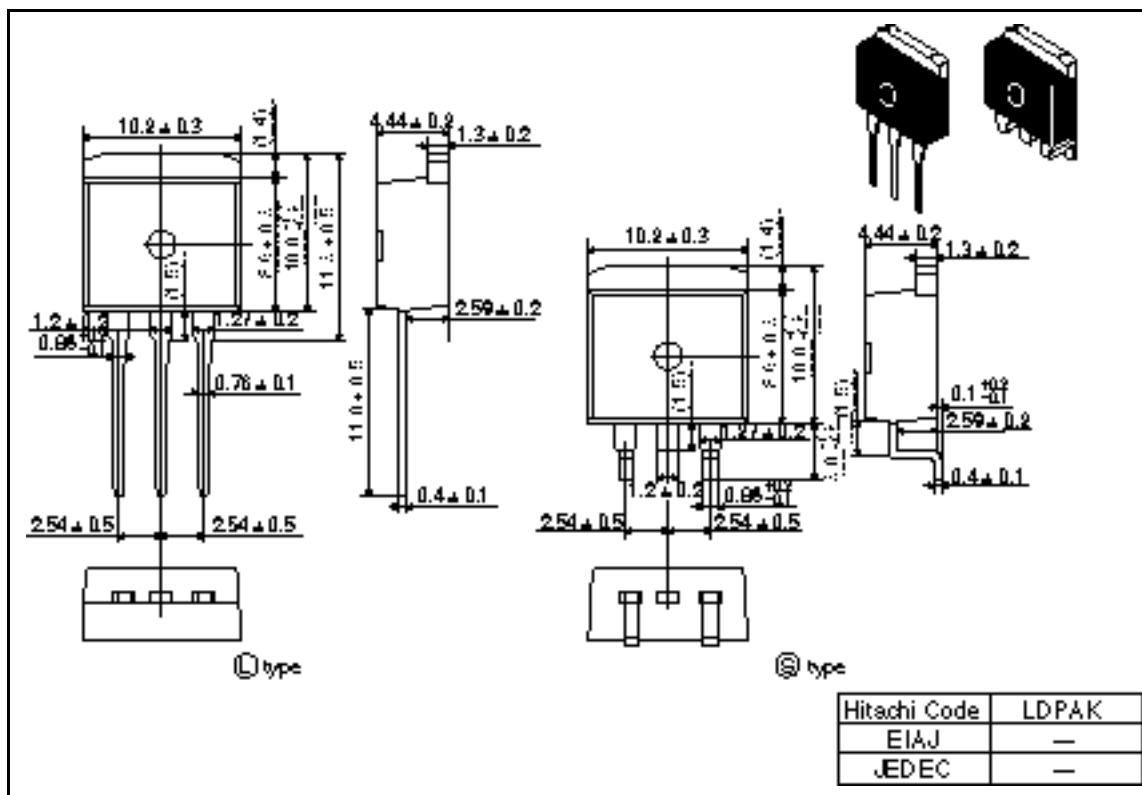
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## **2SK2684(L), 2SK2684(S)**

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### **Package Dimensions**

**Unit: mm**



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